OEM ZIP DIP Sockets



- BeCu contacts assure continuity with very short path to P.C. trace
- Contact design prevents solder bridging and wicking
- Zero insertion/extraction force achieved with simple cam rotation using a screwdriver
- For use where package field replacement or re-programming is required for DIP's
- Socket contact point of .110" (2.79 mm) below top surface of socket
- Pin counts available from 14 through 64 leads on .100" (2.54 mm) centers

Date Issued: October 29, 2001

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Physical

InsulationMaterial:Glass Filled Polyethermide (PEI)Flammability:UL 94V-0Color:BlackMarking:Raised Letters: Textool/3M Logo & Part IdentificationContactMaterial:Beryllium CopperPlatingUnderplate:75 μ " [1.91 μ m] Copper – MIL-C-14550Wiping Area & Solder Tails:250 μ " [6.35 μ m] Tin – MIL-T -10727AOptional PlatingUnderplate:50 μ " [1.27 μ m] NickelWiping Area & Solder Tails:Gold FlashCamMaterial:Zinc

Electrical

Current Rating:1 AInsulation Resistance:> $1 \times 10^{12} \Omega$ at 500 VdcWithstanding Voltage:1000 Vrms at Sea Level

Mechanical

Durability: 100 actuations **Normal Force:** 150 grams average per contact

Environmental

Temperature Rating Operating: - 55 °C to +105 °C

UL File No.: E68080

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